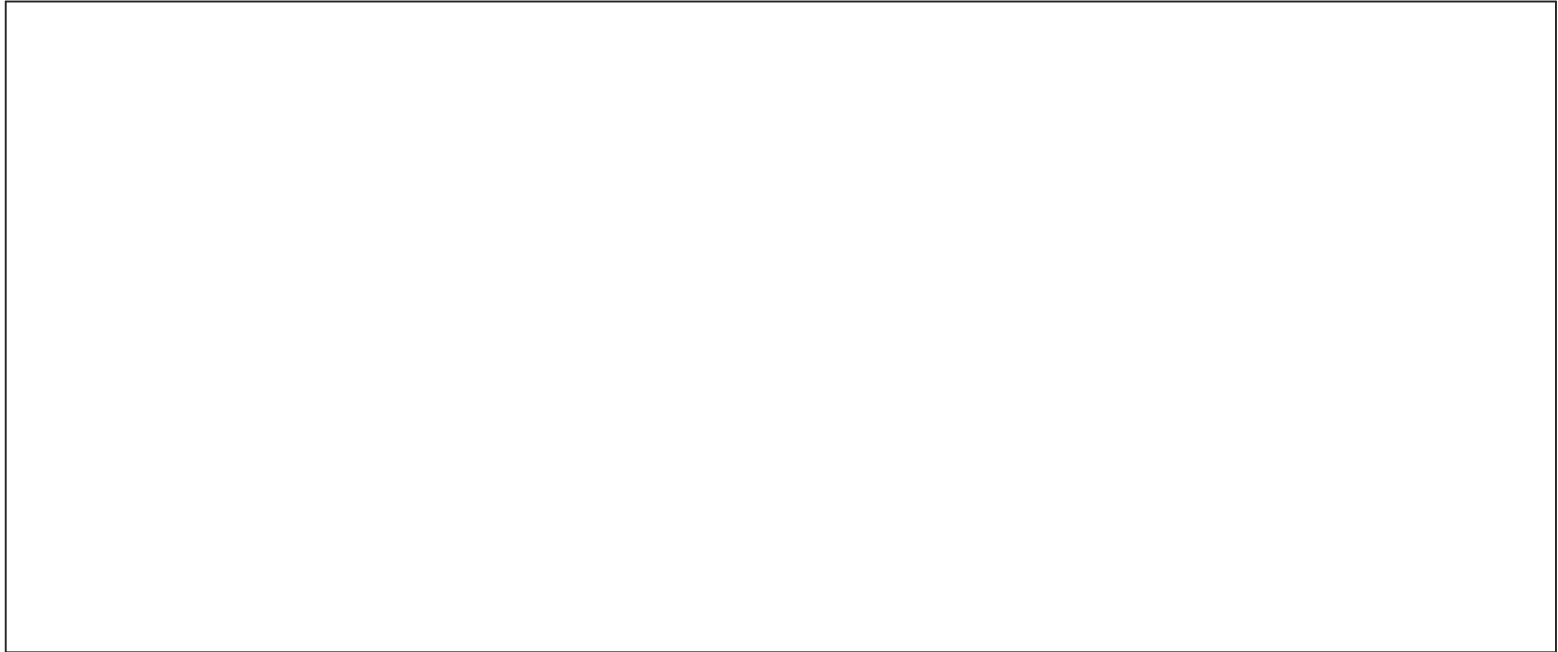


TABLE 1

Variant	Label text
001	ChangeMe!
002	ChangeMe!

PCB VIEWED FROM TOP SIDE	BOARD #: PMP9010	REV: A	SUN REV: Not In VersionControl
IGNORE -> Top Overlay			
PLOT NAME = Top Assembly Drawing	GENERATED : 6/21/2013	9:00:26 AM	TEXAS INSTRUMENTS



PCB VIEWED FROM BOTTOM SIDE	BOARD #: PMP9010	REV: A	SUN REV: Not In VersionControl
	IGNORE -> Bottom Overlay		
PLOT NAME = Bottom Assembly Drawing	GENERATED : 6/21/2013 9:00:27 AM	TEXAS INSTRUMENTS	

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